

/ Descriptions

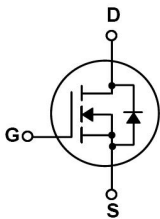
/ Features

1 1

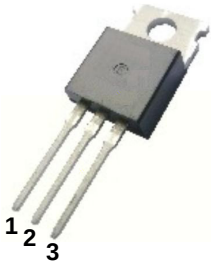
/ Applications

DC/DC

/ Equivalent Circuit

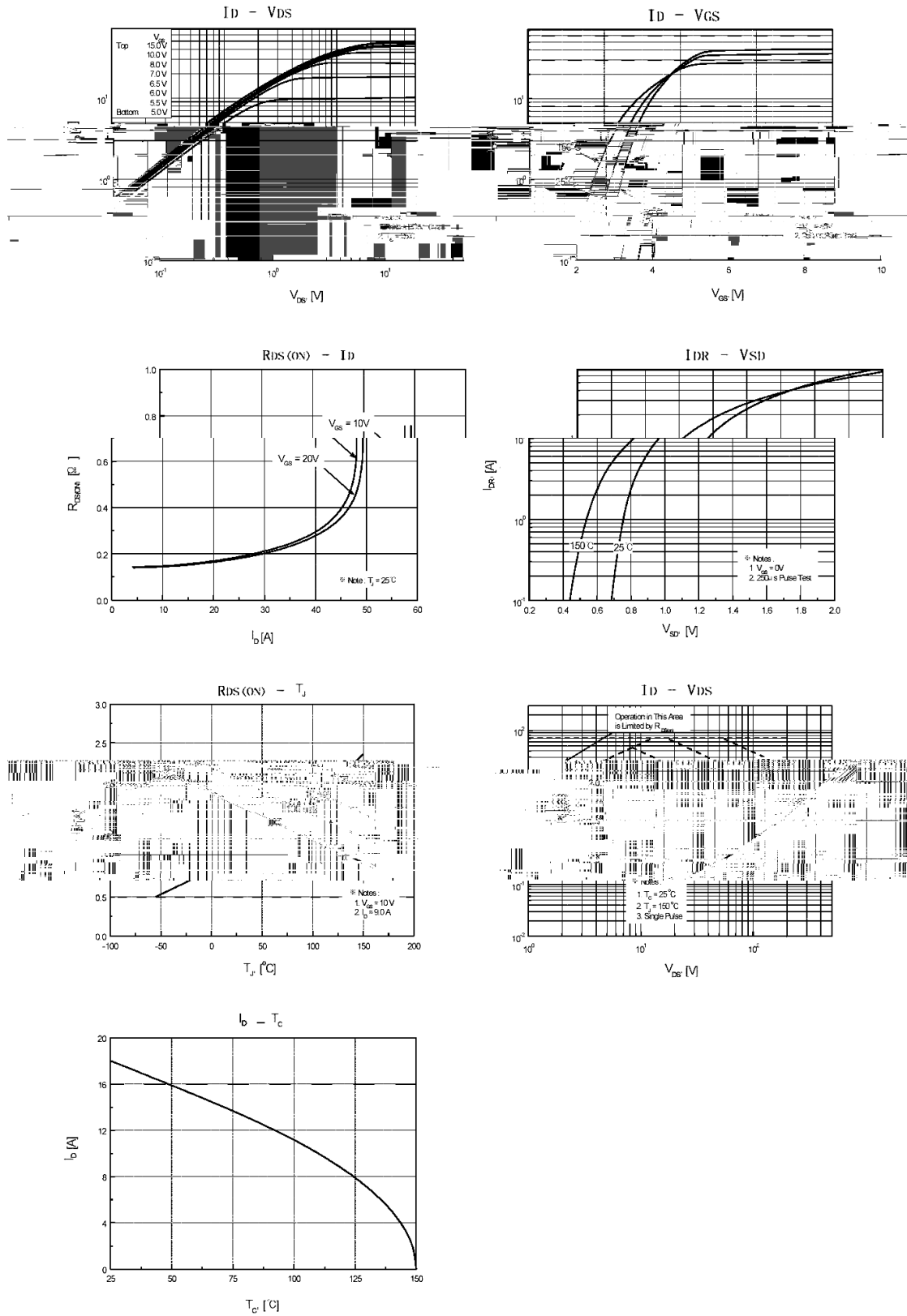


/ Pinning

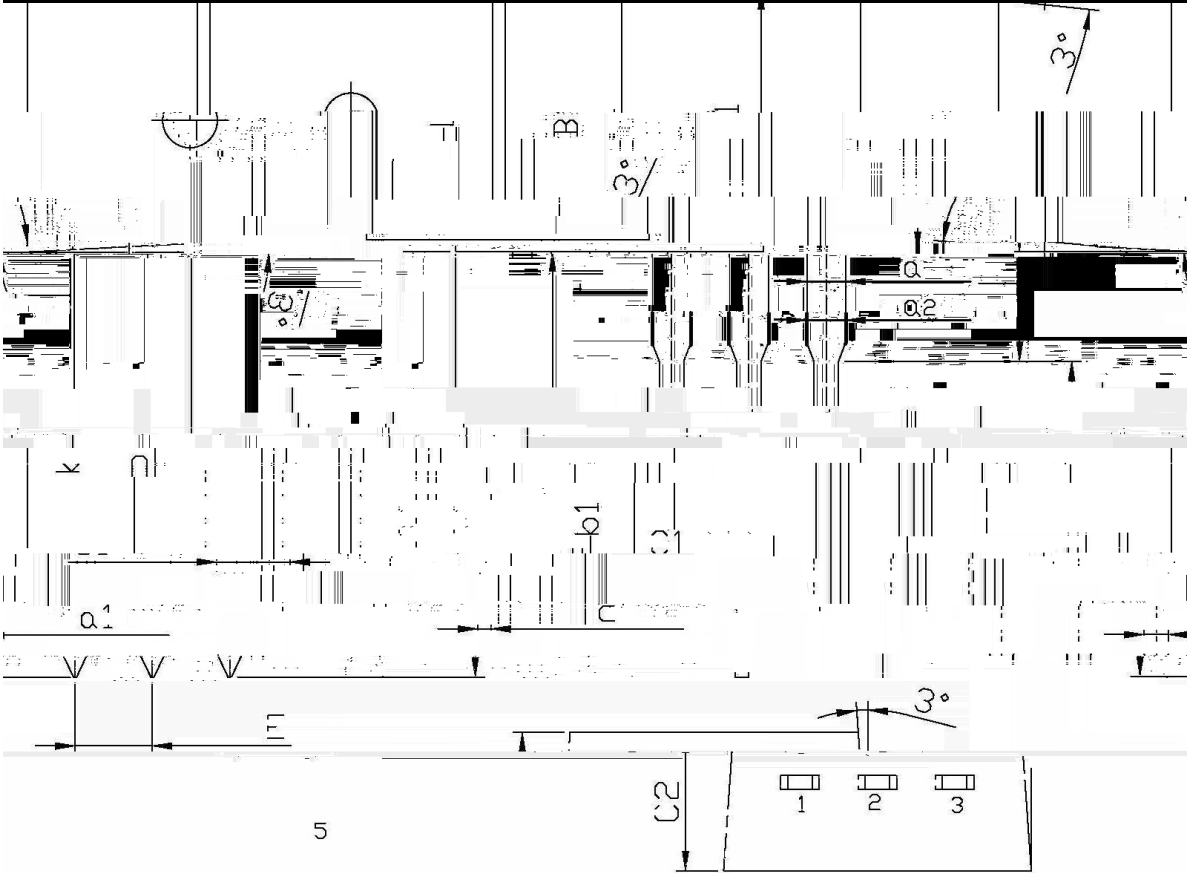
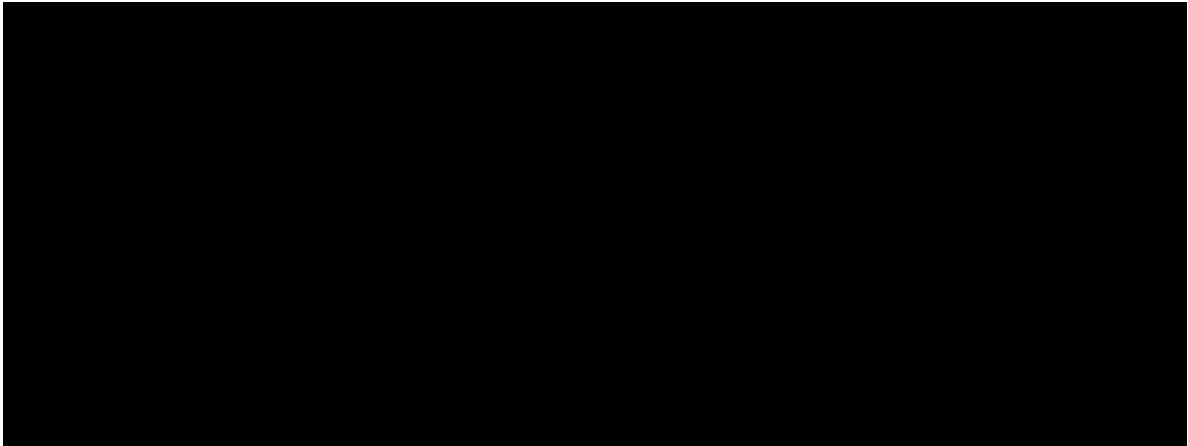


/ h_{FE} Classifications & Marking

/ Electrical Characteristic Curve

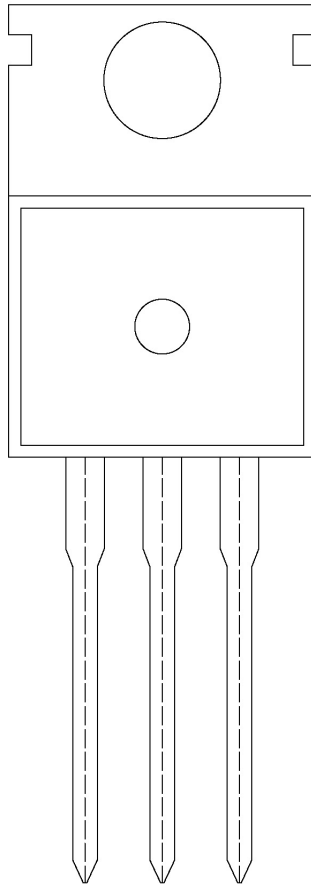


/ Package Dimensions



Dimensions in Millimeters				Dimensions in Millimeters			
Symbol	Min	Max	Typ	Symbol	Min	Max	Typ
Δ	9.8	10.2		C	1.2		
ϕ	3.56	3.64		B ϕ	6.3		
J	15.7	16.1		B	9.0		9
b	12.6	13.6		C1	2.2		2
b1	9.6	10.6		a1	0.7		0
C	1.3	1.4		3	1.4	1.5	1.45
E	13.5	14.7		E	23.4	27.4	
Q2				Q2	1.25	1.45	

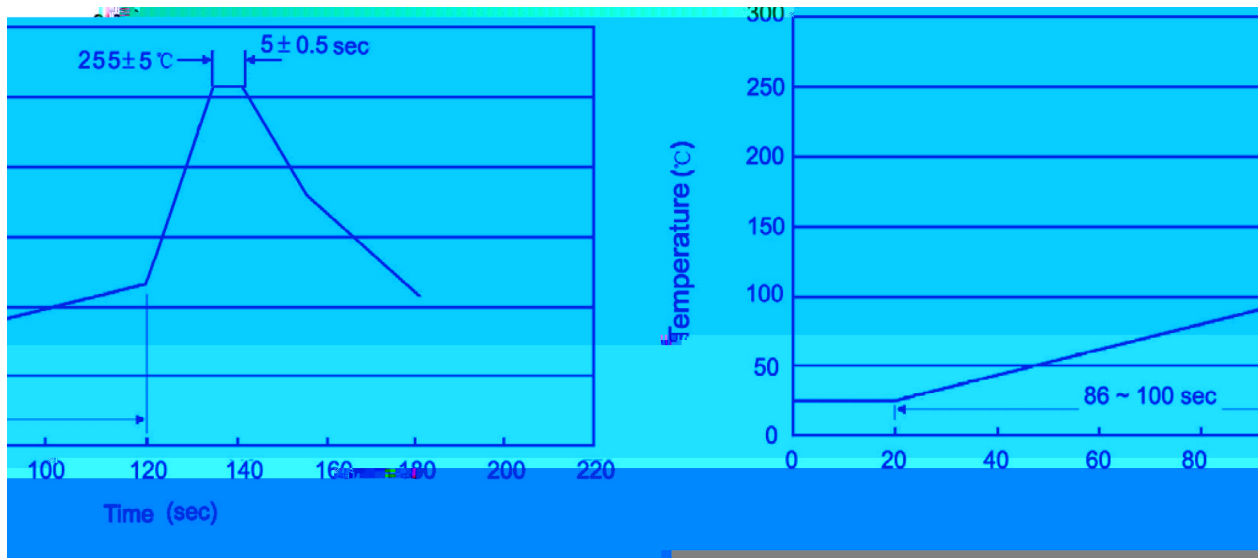
/ Marking Instructions



IRF640

IRF640

() / Temperature Profile for Dip Soldering(Pb-Free)

 $\pm$ $\pm$ $\pm$ $\pm$

/ Resistance to Soldering Heat Test Conditions

 $\pm$ $\pm$

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只袋	袋盒	只盒	盒箱	只箱	袋	盒	箱

封装形式	包装数量					包装尺寸		
	只 套管	套管 盒	只 盒	盒 箱	只 箱	套管	盒	箱

/ Notices